DATA SHEET



LCM MODULE

TC1602A-08B 120421

Specification for Approval

APPROVED BY	CHECKED BY	PREPARED BY

ISSUED: V00 2011-06-07

CONTENTS

FUNCTIONS & FEATURES	3
BLOCK DIAGRAM	3
MODULE OUTLINE DRAWING	4
INTERFACE PIN FUNCTIONS	5
ABSOLUTE MAXIMUM RATINGS (Ta = 25° C)	5
DC ELECTRICAL CHARACTERISTICS	5
LED BACKLIGHT CHARACTERISTICS	5
CONNECTION WITH MCU	6
Typical V0 connections for display contrast	6
MPU Interface 4-Bit/8-Bit	6
AC CHARACTERISTICS	7
OPTICAL CHARACTERISTICS	9
COMMAND TABLE	11
RESET FUNCTIONS	12
DISPLAY DATA RAM (DDRAM)	14
CHARACTER GENERATOR ROM	15
RELIABILITY TEST CONDITION	16
PRECAUTION FOR USING LCM MODULE	17
OTHERS	17
APPENDIX A: DATE CODE RULES	18
APPENDIX B: CHANGE NOTES	18

FUNCTIONS & FEATURES

Construction

Display Format

Display Type

Controller

Interface

Backlight

Viewing Direction

Driving Scheme

Power Supply Voltage

• V_{LCD} Adjustable For Best Contrast

Operation temperature

• Storage temperature

: COB(Chip-on-Board)

: 16x2 Characters

: FSTN, Transmissive, Positive, B-W

: SPLC780D1 or equivalent controller

: 8-bit parallel interface

: blue\side light

: 6 O'clock

: 1/16 Duty Cycle, 1/5 Bias

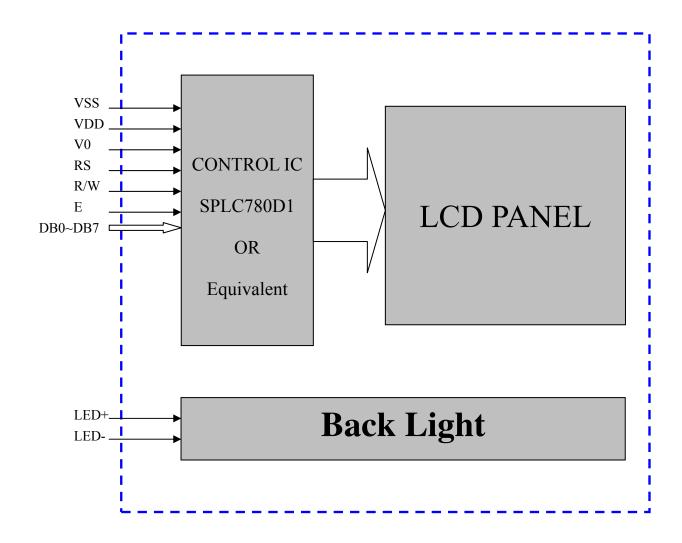
: 5.0 V

 $: 5.0 \text{ V } (V_{OP}.)$

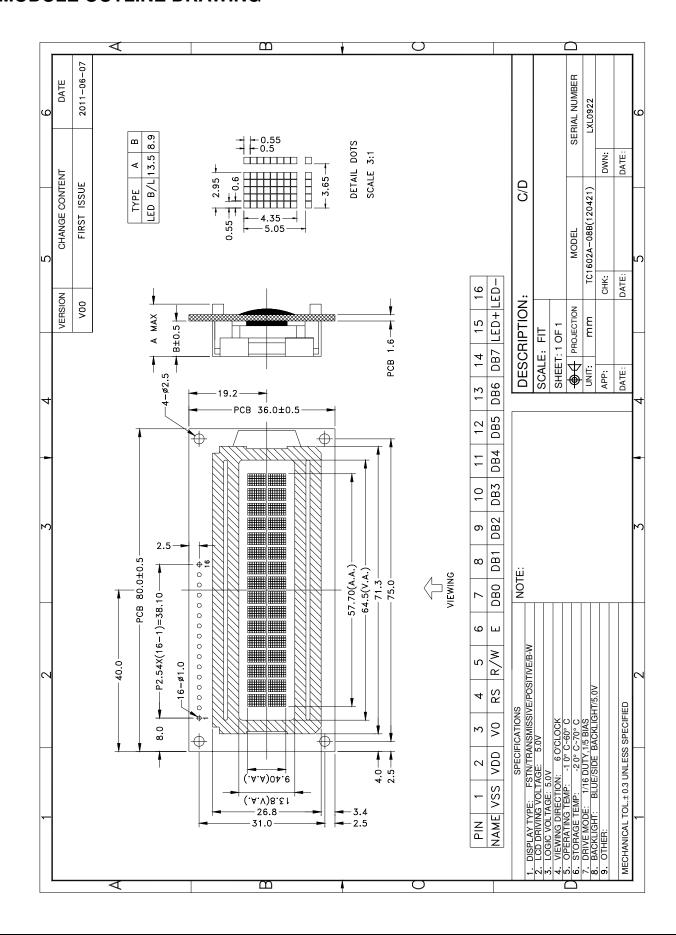
: -10°C to +60°C

: -20°C to +70°C

BLOCK DIAGRAM



MODULE OUTLINE DRAWING



INTERFACE PIN FUNCTIONS

Pin No.	Symbol	Level	Description
1	VSS	0V	Ground.
2	VDD	+5.0V	Power supply for logic operating.
3	V0		Adjusting supply voltage for LCD driving.
			A signal for selecting registers:
4	RS	H/L	1: Data Register (for read and write)
			0: Instruction Register (for write), Busy flag-Address Counter (for read).
5	R/W	H/L	R/W = "H": Read mode.
3	K/ W	II/L	R/W = "L": Write mode.
6	E	H/L	An enable signal for writing or reading data.
7	DB0	H/L	
8	DB1	H/L	
9	DB2	H/L	
10	DB3	H/L	This is an 8-bit bi-directional data bus.
11	DB4	H/L	
12	DB5	H/L	
13	DB6	H/L	
14	DB7	H/L]
15	LED+	+5.0V	Power supply for backlight.
16	LED-	0V	The backlight ground.

ABSOLUTE MAXIMUM RATINGS (Ta = 25° C)

Parameter	Symbol	Min	Max	Unit
Supply voltage for logic	$V_{ m DD}$	-0.3	+7.0	V
Supply voltage for LCD	Vo	0	V _{DD} +0.3	V
Input voltage	$V_{\rm I}$	-0.3	V _{DD} +0.3	V
Normal Operating temperature	Тор	-20	+70	$^{\circ}$
Normal Storage temperature	Tst	-30	+80	$^{\circ}$

Note: Stresses beyond those given in the Absolute Maximum Rating table may cause operational errors or damage to the device. For normal operational conditions see AC/DC Electrical Characteristics.

DC ELECTRICAL CHARACTERISTICS

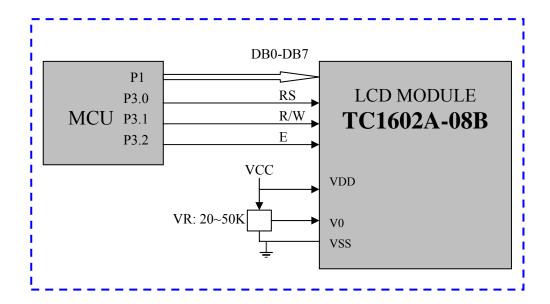
Parameter	Symbol	Condition	Min	T_{YP}	Max	Unit
Supply voltage for logic	VDD		4.8	5.0	5.2	V
Supply current for logic	IDD			16	200	mA
		-10℃				
Operating voltage for LCD	VLCD	25℃	4.8	5.0	5.2	V
		+60°C				
Input voltage "H" level	VIH		0.7 VDD		VDD+0.3	V
Input voltage "L" level	VIL		0		0.2VDD	V

LED BACKLIGHT CHARACTERISTICS

COLOR	Wavelength λ p(nm)	Operating Voltage($\pm 0.15V$)	Spectral line half width Δ λ (nm)	Forward Current (mA)
	N p(IIIII)	voitage(± 0.13 v)	width \(\Delta \text{R} \) (IIII)	(IIIA)
blue		3.1		15

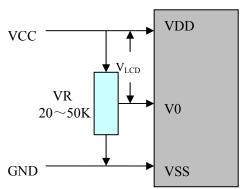
NOTE: Do not connect +5V directly to the backlight terminals. This will ruin the backlight.

CONNECTION WITH MCU



(1) Typical V0 connections for display contrast

Adjust V0 to +5.0V (VLCD=+5V) as an initial setting. When the module is operational, readjust V0 for optimal display appearance.



We recommend allowing field adjustment of V0 for all designs. The optimal value for V0 will change with temperature, variations in VDD, and viewing angle. V0 will also vary module-to-module and batch-to-batch due to normal manufacturing variations.

Ideally, adjustment to V0 should be available to the end user so each user can adjust the display to the optimal contrast for their required viewing conditions. As a minimum, your design should allow V0 to be adjusted as part of your product's final test.

Although a potentiometer is shown as a typical connection, V0 can be driven by your microcontroller, either by using a DAC or a filtered PWM. Displays that require V0 to be negative may need a level-shifting circuit. Please do not hesitate to contact Tinsharp application support for design assistance on your application.

(2) MPU Interface 4-bit/8-Bit

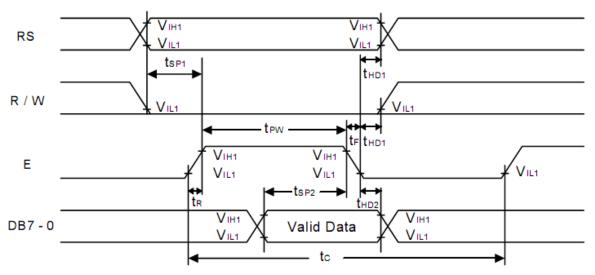
There are tow types of data operations: 4-bit and 8-bit operations. Using 4-bit MPU, the interfacing 4-bit data is transferred by 4-busline (DB4 \sim DB7). Thus, DB0 to DB3 bus lines are not used. Using 4-bit MPU to interface 8-bit data requires tow times transferring. First, the higher 4-bit data is transferred by 4-busline (for 8-bit operation, DB7 \sim DB4). Secondly, the lower 4-bit data is transferred by 4-busline (for 8-bit operation, DB3 \sim DB0). For 8-bit MPU, the 8-bit data is transferred by 8-busline (DB0 \sim DB7).

AC CHARACTERISTICS

(1) Write Mode (Writing data from MPU to SPLC780D1)

Ohamatariatiaa	Complete		Limit			Total Constitution
Characteristics	Symbol	Min.	Тур.	Max.	Unit	lest Condition
E Cycle Time	Symbol Min. Typ. Max. Unit Test Condition t _C 400 - - ns Pin E t _{PW} 150 - - ns Pin E t _R , t _F - - 25 ns Pin E me t _{SP1} 30 - - ns Pins: RS, R/W, E e t _{HD1} 10 - - ns Pins: RS, R/W, E t _{SP2} 40 - - ns Pins: DB0 - DB7					
E Pulse Width	Min. Typ. Max. Cycle Time t _C 400 - - ns Pin E Pulse Width t _{PW} 150 - - ns Pin E Rise/Fall Time t _R , t _F - - 25 ns Pin E ddress Setup Time t _{SP1} 30 - - ns Pins: RS, R/W, E ddress Hold Time t _{HD1} 10 - - ns Pins: RS, R/W, E				Pin E	
E Rise/Fall Time	t _R , t _F	-	-	25	Max. Pin E - ns Pin E - ns Pin E 25 ns Pin E - ns Pins: RS, R/W, E - ns Pins: RS, R/W, E	
Address Setup Time	t _{SP1}	30	-	Typ. Max. Unit Test Condition - - ns Pin E - - ns Pin E - - ns Pins: RS, R/W, E - - ns Pins: RS, R/W, E - - ns Pins: DB0 - DB7		
Address Hold Time	t _{HD1}	10	-	A AK	ns	Pins: RS, R/W, E
Data Setup Time	t _{SP2}	40	-		ns	Pins: DB0 - DB7
Data Hold Time	t _{HD2}	10	-	$M_{i, \alpha}$	ns	Pins: DB0 - DB7

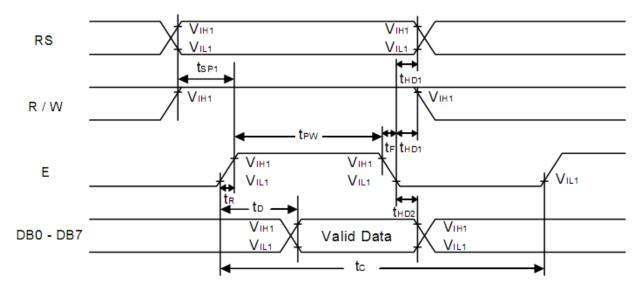
Write Mode Timing Diagram (Writing data from MPU to SPLC780D1)



(2) Read Mode (Reading data from SPLC780D1 to MPU)

Observatoristics	Complete		Limit		l lmit	To at Coundition
E Cycle Time E Pulse Width E Rise/Fall Time Address Setup Time Address Hold Time	Symbol	Min.	Тур.	Тур. Мах.		Test Condition
Characteristics Symbol Min. Typ. Max. Unit Test Condition E Cycle Time t _C 400 - - ns Pin E E Pulse Width t _W 150 - - ns Pin E E Rise/Fall Time t _R , t _F - - 25 ns Pin E Address Setup Time t _{SP1} 30 - - ns Pins: RS, R/W, E		Pin E				
E Pulse Width	t _W	150		- 4	ns	Pin E
E Rise/Fall Time	t _R , t _F	DU	-	25	ns	Pin E
Address Setup Time	t _{SP1}	30	-		ns	Pins: RS, R/W, E
Address Hold Time	t _{HD1}	10	-		ns	Pins: RS, R/W, E
Data Output Delay Time	t _D	-	- 4	100	ns	Pins: DB0 - DB7
Data hold time	t _{HD2}	5.0	-	<i>y</i> '-	ns	Pin DB0 - DB7

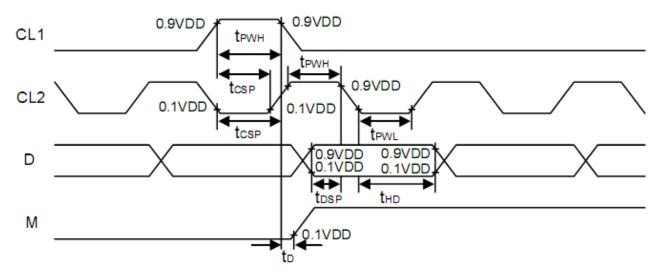
Read Mode Timing Diagram (Reading data from SPLC780D1 to MCU)



(3) Interface mode with LCD driver (SPLC100B1)

a)	C		Limit		11.2	T (0 10			
Characteristics	Symbol	Min.	Тур.	Max.	Unit	Test Condition			
Clock pulse width high	t _{PWH}	800		-	ns	Pins: CL1, CL2			
Clock pulse width low	t _{PWL}	800	-	-	ns	Pins: CL1, CL2			
Clock setup time	tose	500		-	ns	Pins: CL1, CL2			
Data setup time	t _{DSP}	300	•	-	ns	Pins: D			
Data hold time	t _{HD}	300	•	-	ns	Pins: D			
M delay time	t _D	-1000	•	1000	ns	Pins: M			

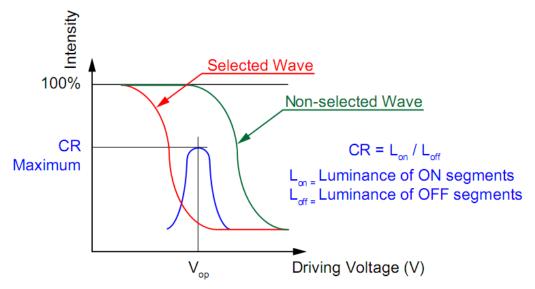
Interface mode with SPLC100B1 Timing Diagram

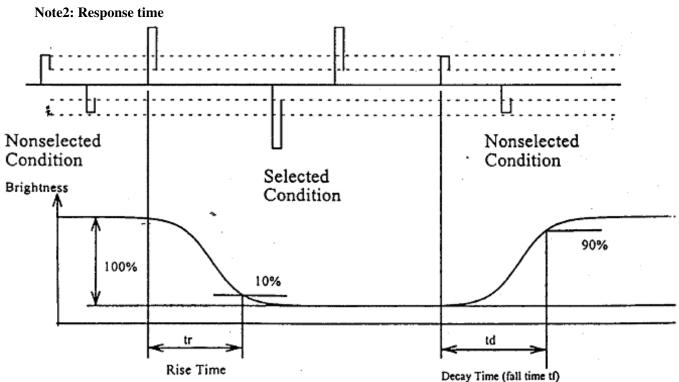


OPTICAL CHARACTERISTICS

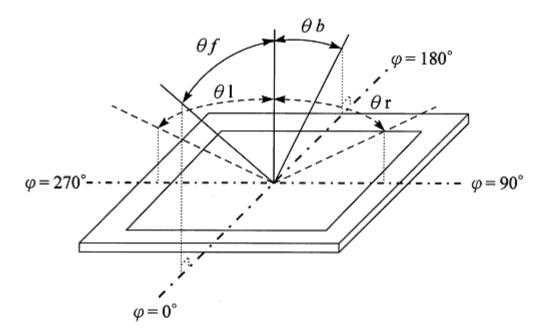
ITEM	SYMBOL	CONDITION	MIN	TYP	MAX	UNIT	NOTE
Contrast ratio	CR	$\theta=0, \Phi=0$	1	3	-		
Response time(rise)	Tr	25℃		-	250	me	
Response time(fall)	Td	25 C		-	350	ms	
	θf						
Vioving angle	θЬ	25℃					
Viewing angle	θ1	250		-		dog	
	θr			-		deg.	

Note1: Definition Operation Voltage (V_{OP})





Note3: Viewing angle



COMMAND TABLE

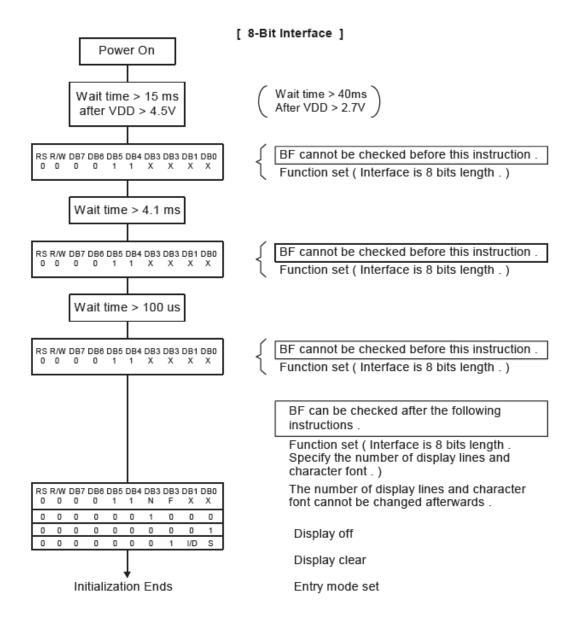
			,	Ins	tructi	on Co	ode				\		ecution ti	
Instruction	RS	RW	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Description	Fosc= 190KHz	Fosc= 270KHz	Fosc= 350KHz
Clear Display	0	0	0	0	0	0	0	0	0	1	Write "20H" to DDRAM and set DDRAM address to "00H" from AC	2.16ms	1.52ms	1.18ms
Return Home	0	0	0	0	0	0	0	0	3 (Set DDRAM address to "00H" from AC and return cursor to its original position if shifted. The contents of DDRAM are not changed.	2.16ms	1.52ms	1.18ms
Entry Mode Set	0	0	0	0	0	0	0	7	I/D	S	Assign cursor moving direction and enable the shift of entire display	53µs	38µs	29μs
Display ON/ OFF Control	0	0	0	0	0	0	1	D	С	В	Set display (D), cursor(C), and blinking of cursor(B) on/off control bit.	53μs	38µs	29μs
Cursor or Display Shift	0	0	0	0	0	1	S/C	R/L			Set cursor moving and display shift control bit, and the direction, without changing of DDRAM data.	53μs	38μs	29μs
Function Set	0	0	0	0	-	DL	N	F	-	1	Set interface data length (DL: 8-bit/4-bit), numbers of display line (N: 2-line/1-line) and, display font type (F:5x10 dots/5x8 dots)	53μs	38µs	29µs
Set CGRAM Address	0	0	0	1	AC5	AC4	AC3	AC2	AC1	AC0	Set CGRAM address in address counter.	53μs	38μs	29μs
Set DDRAM Address	0	0	1	AC6	AC5	AC4	AC3	AC2	AC1	AC0	Set DDRAM address in address counter	53μs	38μs	29μs
Read Busy Flag and Address Counter	0	1	BF	AC6	AC5	AC4	AC3	AC2	AC1	AC0	Whether during internal operation or not can be known by reading BF. The contents of address counter can also be read.			
Write Data to RAM	1	0	D7	D6	D5	D4	D3	D2	D1	D0	Write data into internal RAM (DDRAM/CGRAM).	53μs	38μs	29μs
Read Data from RAM	1	1	D7	D6	D5	D4	D3	D2	D1	D0	Read data from internal RAM (DDRAM/CGRAM).	53μs	38μs	29µs

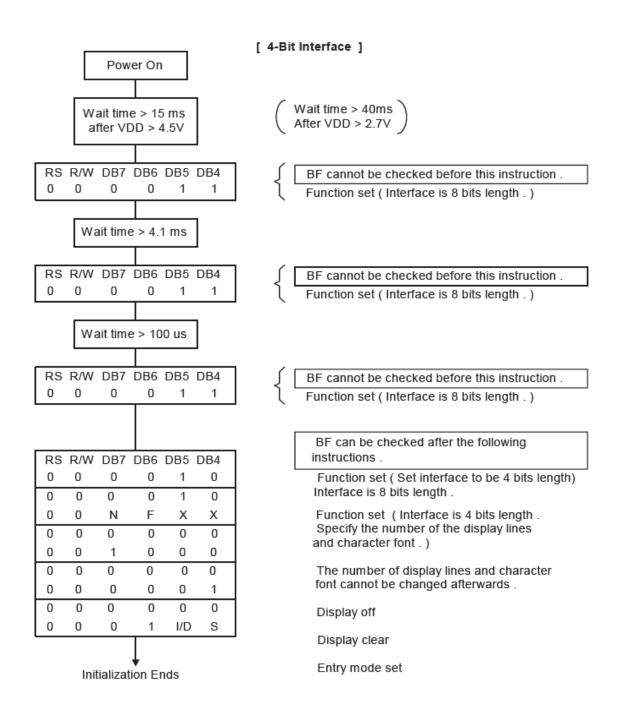
Note1: "--": don't care

Note2: In the operation condition under -20°C ~ 75°C, the maximum execution time for majority of instruction sets is 100us, except two instructions, "Clear Display" and "Return Home", in which maximum execution time can take up to 4.1ms.

RESET FUNCTION

At power on, SPLC780D1 starts the internal auto-reset circuit and executes the initial instructions. The initial procedures are shown as follows:





DISPLAY DATA RAM (DD RAM)

The 80-bit DD RAM is normally used for storing display data. Those DD RAM not used for display data can be used as general data RAM. Its address is configured in the Address Counter.

2 LINES X 16 CHARACTERS PER LINE																
Char.	1	2	3	4	5	б	7	8	9	10	11	12	13	14	15	16
Line 1	80	81	82	83	84	85	86	87	88	89	8 A	8B	8C	8D	8E	8 F
Line 2	CO	Cl	C2	С3	C4	C5	C6	C7	C8	C9	CA	СВ	cc	CD	CE	CF

Timing Generation Circuit

The timing generating circuit is able to generate timing signals to the internal circuits. In order to prevent the internal timing interface, the MPU access timing and the RAM access timing are generated independently.

LCD Driver Circuit

Total of 16 commons and 40 segments signal drivers are valid in the LCD driver circuit. When a program specifies the character fonts and line numbers, the corresponding common signals output drive-waveforms and the others still output unselected waveforms. The relationships between Display Data RAM Address and LCD's position are depicted as follows.

Character Generator ROM (CG ROM)

Using 8-bit character code, the character generator ROM generates 5 x 8 dots or 5 x 10 dots character patterns. It also can generate 192's 5 x 8 dots character patterns and 64's 5 x 10 dots character patterns.

Character Generator RAM (CG RAM)

Users can easily change the character patterns in the character generator RAM through program. It can be written to 5×8 dots, 8-character patterns or 5×10 dots for 4-character patterns.

CHARACTER GENERATOR ROM

SPLC780D1-021A:

	0022	·														
Upper 4 bit Lower 4 bit	LLLL	LLLH	LLHL	LLHH	LHLL	LHLH	LHHL	LHHH	HLLL	HLLH	HLHL	HLHH	HHLL	HELH	HHHL	нын
LLLL								F					H			
LLLH																
LLHL						R							Ä			
LLHH																
LHLL											шш					
LHLH																
LHHL						The second second										
LHHH																
HLLL		ľ														
HILH																
HLHL									 							
нтнн					×			×			*	*				
HHLL				ď											1	
HHLH									Ŀ					Ŷ	Ĭ	
HEHL				Þ				•						Þ	1	
нннн				Ħ								₫,				

RELIABILITY TEST CONDITION

No.	TEST Item Content of Test		Test Condition	Applicable Standard
1	High temperature Endurance test applying the high storage storage Temperature for a long time.		70° C 96hrs	
2	Low temperature storage	Endurance test applying the low storage Temperature for a long time	-20° C 96hrs	
3	High temperature operation	Endurance test applying the electric stress (Voltage & current)and the thermal stress to the element for a long time	60° C 96hrs	
4	Low temperature Endurance test applying the electric stress operation Under low temperature for a long time		-10° C 96hrs	
5	High temperature/ Humidity storage	Endurance test applying the electric stress(Voltage & current) and Temperature/ Humidity stress to the element for a long time	40° C 90%RH 96hrs	
6	High temperature/ Humidity operation	Endurance test applying the electric stress (voltage & current)and temperature/ humidity stress to the element for a long time	40° C 90%RH 96hrs	
7	Temperature cycle	Endurance test applying the low and high temperature cycle10° C →25° C→60° C 30min←5min←30min.(1 cycle)	-10° C/60° C 10 cycle	

Supply voltage for logic system = 5V. Supply voltage for LCD system = Operating voltage at 25° C.

Mechanical Test

Vibration test	Endurance test applying the vibration during transportation and using	10~22Hz→1.5mmp-p 22~500Hz→1.5G Total 0.5hour
Shock test	Constructional and mechanical endurance test applying the shock during transportation.	50G half sign wave 11 msede 3 times of each direction
Atmospheric pressure test	Endurance test applying the atmospheric pressure during transportation by air	115mbar 40hrs
Static electricity test	Endurance test applying the electric stress to the terminal	VS=800V,RS-1.5K Ω CS=100pF, 1 time

Environmental condition

The inspection should be performed at the 1metre height from the LCD module under 2 pieces of 40W white fluorescent lamps (Normal temperature $20\sim25\,^{\circ}$ C and normal humidity $60\pm15\%$ RH).

PRECAUTION FOR USING LCM MODULE

- Please remove the protection foil of polarizer before using.
- The display panel is made of glass. Do not subject it to a mechanical shock by dropping it from a high place, etc.
- If the display panel is damaged and the liquid crystal substance inside it leaks out, do not get any in your mouth. If the substance come into contact with your skin or clothes promptly wash it off using soap and water.
- Do not apply excessive force to the display surface or the adjoining areas since this may cause the color tone to vary.
- The polarizer covering the display surface of the LCD module is soft and easily scratched. Handle this polarize carefully.
- To prevent destruction of the elements by static electricity, be careful to maintain an optimum work environment.
 - -Be sure to ground the body when handling the LCD module.
 - -Tools required for assembly, such as soldering irons, must be properly grounded.
 - -To reduce the amount of static electricity generated, do not conduct assembly and other work under dry conditions.
 - -The LCD module is coated with a film to protect the display surface. Exercise care when peeling off this protective film since static electricity may be generated.
- Storage precautions
 - When storing the LCD modules, avoid exposure to direct sunlight or to the light of fluorescent lamps.
 - Keep the modules in bags designed to prevent static electricity charging under low temperature / normal humidity conditions (avoid high temperature / high humidity and low temperatures below 0° C). Whenever possible, the LCD modules should be stored in the same conditions in which they were shipped from our company.

OTHERS

- Liquid crystals solidify at low temperature (below the storage temperature range) leading to defective orientation of liquid crystal or the generation of air bubbles (black or white). Air bubbles may also be generated if the module is subjected to a strong shock at a low temperature.
- If the LCD modules have been operating for a long time showing the same display patterns may remain on the screen as ghost images and a slight contrast irregularity may also appear. Abnormal operating status can be resumed to be normal condition by suspending use for some time. It should be noted that this phenomena does not adversely affect performance reliability.
- To minimize the performance degradation of the LCD modules resulting from caused by static electricity, etc. exercise care to avoid holding the following sections when handling the modules:
 - Exposed area of the printed circuit board
 - Terminal electrode sections

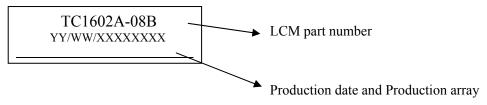
A. DATE CODE RULES

A.1. DATE CODE FOR SAMPLE

YP: meaning sample



A.2. DATE CODE FOR PRODUCTION



A. TC1602A-08B represents LCM part number

C. YY/WW represents Year, Week

YY—Year WW—Week

XXXXXXX—Production array No.

B. CHANGE NOTES:

Ver.	Descriptions	Editor	Date
V00	First Issue	ZXQ	2011-06-07